

1.6x0.6mm RIGHT ANGLE SMD CHIP LED **LAMP**



ATTENTION OBSERVE PRECAUTIONS FOR HANDLING ELECTROSTATIC DISCHARGE SENSITIVE **DEVICES**

Part Number: APA1606SURCK

Hyper Red

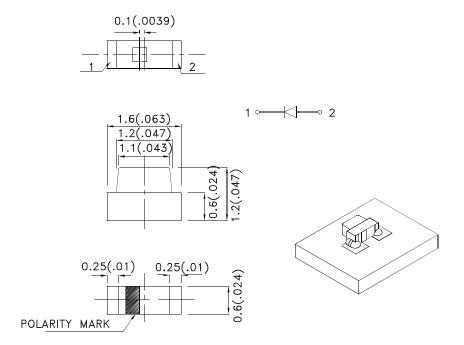
Features

- 1.6mmx1.2mmx0.6mm right angle SMD LED,0.6mm thickness.
- Low power consumption.
- Wide viewing angle.
- Ideal for backlight and indicator.
- Package :2000pcs / reel.
- Moisture sensitivity level : level 3.
- Tinned pads for improved solderability.
- RoHS compliant.

Descriptions

- The Hyper Red source color devices are made with Al GaInP on GaAs substrate Light Emitting Diode.
- Electrostatic discharge and power surge could damage the LEDs.
- It is recommended to use a wrist band or antielectrostatic glove when handling the LEDs.
- All devices, equipment and machinery must be electri cally grounded.

Package Dimensions







- 1. All dimensions are in millimeters (inches).
- 2. Tolerance is $\pm 0.1 (0.004")$ unless otherwise noted.
- The specifications, characteristics and technical data described in the datasheet are subject to change without prior notice.
 The device has a single mounting surface. The device must be mounted according to the specifications.

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Selection Guide

| Part No. | Emitting Color (Material) | Lens Type | lv (mcd) [2] @ 20mA | | Viewing Angle [1] |
|--------------|---------------------------|-------------|------------------------|------|----------------------|
| | | | Min. | Тур. | 201/2 |
| APA1606SURCK | Hyper Red (AlGaInP) | Water Clear | 120 | 220 | - 110° |
| | | Water Clear | *40 | *80 | |

Notes:

- $1. \theta 1 / 2$ is the angle from optical centerline where the luminous intensity is 1 / 2 of the optical peak value.
- 2. Luminous intensity / luminous Flux: + / -15%.
- * Luminous intensity value is traceable to CIE127-2007 standards.

Electrical / Optical Characteristics at TA=25°C

| Symbol | Parameter | Emitting Color | Тур. | Max. | Units | Test Conditions |
|--------|--------------------------|----------------|------|------|-------|--------------------|
| λpeak | Peak Wavelength | Hyper Red | 645 | | nm | IF=20mA |
| λD [1] | Dominant Wavelength | Hyper Red | 630 | | nm | IF=20mA |
| Δλ1/2 | Spectral Line Half-width | Hyper Red | 28 | | nm | IF=20mA |
| С | Capacitance | Hyper Red | 35 | | pF | VF=0V;f=1MHz |
| VF [2] | Forward Voltage | Hyper Red | 1.95 | 2.5 | V | IF=20mA |
| lr | Reverse Current | Hyper Red | | 10 | uA | V _R =5V |

Notes:

- Wavelength: + / -1nm.
 Forward Voltage: + / -0.1V.
- 3. Wavelength value is traceable to CIE127-2007 standards.
- 4. Excess driving current and / or operating temperature higher than recommended conditions may result in severe light degradation or premature failure.

Absolute Maximum Ratings at TA=25°C

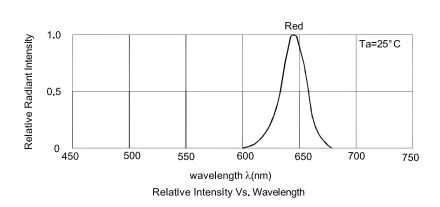
| Parameter | Values | Units | |
|--------------------------|----------------|-------|--|
| Power dissipation | 75 | mW | |
| DC Forward Current | 30 | mA | |
| Peak Forward Current [1] | 185 | mA | |
| Reverse Voltage | 5 | V | |
| Operating Temperature | -40°C To +85°C | | |
| Storage Temperature | -40°C To +85°C | | |

Notes:

- 1. 1/10 Duty Cycle, 0.1ms Pulse Width.
- 2. Relative humidity levels maintained between 40% and 60% in production area are recommended to avoid the build-up of static electricity Ref JEDEC/JESD625-A and JEDEC/J-STD-033.

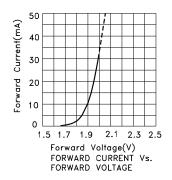
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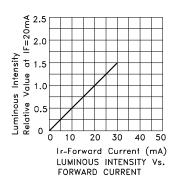
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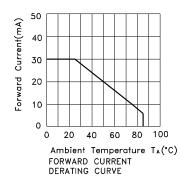


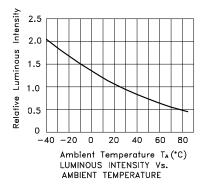
Hyper Red

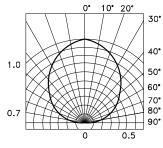
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SPATIAL DISTRIBUTION

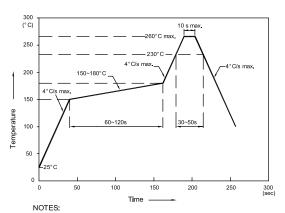
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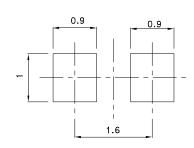
Reflow soldering is recommended and the soldering profile is shown below. Other soldering methods are not recommended as they might cause damage to the product.

Reflow Soldering Profile For Lead-free SMT Process.

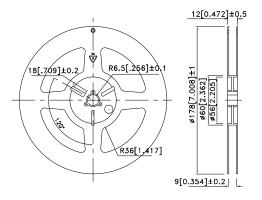


- 1. We recommend the reflow temperature 245°C(+/-5°C). The maximum soldering temperature should be limited to 260°C.
- 2.Don't cause stress to the epoxy resin while it is exposed to high temperature
- to high temperature.
 3.Number of reflow process shall be 2 times or less.

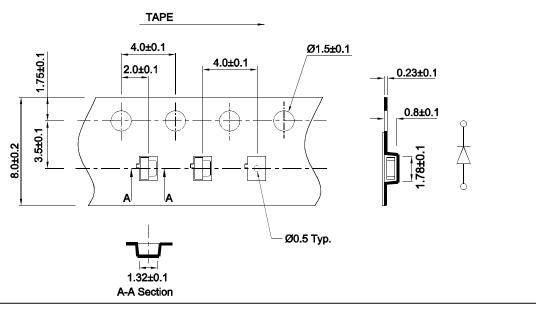
Recommended Soldering Pattern (Units: mm; Tolerance: ± 0.1)



Reel Dimension



Tape Dimensions (Units : mm)



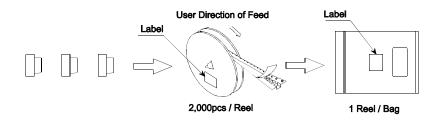
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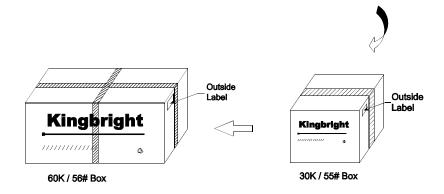
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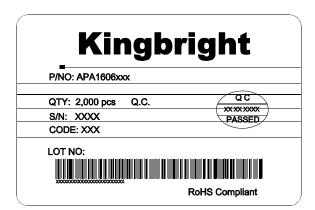
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PACKING & LABEL SPECIFICATIONS

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